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# **DME50101**

## Silicon PNP epitaxial planar type (Tr1) Silicon NPN epitaxial planar type (Tr2)

For general amplification DME20101 in SMini5 type package

#### ■ Features

- $\bullet$  High forward current transfer ratio  $h_{\text{FE}}$  with excellent linearity
- ullet Low collector-emitter saturation voltage  $V_{\text{CE(sat)}}$
- Halogen-free / RoHS compliant
   (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

#### ■ Marking Symbol: A2

#### ■ Basic Part Number

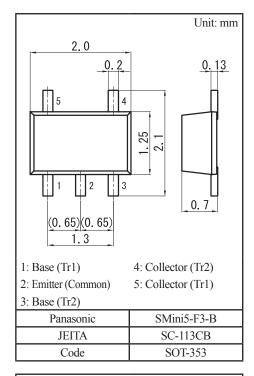
DSA2001 + DSC2001 (Common emitter)

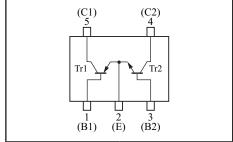
#### ■ Packaging

 $DME501010R \quad Embossed \ type \ (Thermo-compression \ sealing): 3\,000 \ pcs \ / \ reel \ (standard)$ 

## ■ Absolute Maximum Ratings $T_a = 25$ °C

|         | Parameter                             | Symbol           | Rating      | Unit |  |
|---------|---------------------------------------|------------------|-------------|------|--|
| Tr1     | Collector-base voltage (Emitter open) | V <sub>CBO</sub> | -60         | V    |  |
|         | Collector-emitter voltage (Base open) | V <sub>CEO</sub> | -50         | V    |  |
|         | Emitter-base voltage (Collector open) | $V_{EBO}$        | -7          | V    |  |
|         | Collector current                     | $I_{C}$          | -100        | mA   |  |
|         | Peak collector current                | $I_{CP}$         | -200        | mA   |  |
| Tr2     | Collector-base voltage (Emitter open) | V <sub>CBO</sub> | 60          | V    |  |
|         | Collector-emitter voltage (Base open) | V <sub>CEO</sub> | 50          | V    |  |
|         | Emitter-base voltage (Collector open) | $V_{EBO}$        | 7           | V    |  |
|         | Collector current                     | $I_{C}$          | 100         | mA   |  |
|         | Peak collector current                | $I_{CP}$         | 200         | mA   |  |
| Overall | Total power dissipation               | $P_{T}$          | 150         | mW   |  |
|         | Junction temperature                  | T <sub>j</sub>   | 150         | °C   |  |
|         | Operating ambient temperature         | T <sub>opr</sub> | -40 to +85  | °C   |  |
|         | Storage temperature                   | T <sub>stg</sub> | -55 to +150 | °C   |  |





## ■ Electrical Characteristics $T_a = 25$ °C±3°C

#### • Tr1

| Parameter  | Symbol               | Conditions   | Min | Тур   | Max  | Unit |
|--|----------------------|--|-----|-------|------|------|
| Collector-base voltage (Emitter open)                            | $V_{CBO}$            | $I_{\rm C} = -10  \mu \text{A}, I_{\rm E} = 0$       | -60 |       |      | V    |
| Collector-emitter voltage (Base open)                            | V <sub>CEO</sub>     | $I_{\rm C} = -2 \text{ mA}, I_{\rm B} = 0$           | -50 |       |      | V    |
| Emitter-base voltage (Collector open)                            | $V_{\mathrm{EBO}}$   | $I_E = -10 \mu A, I_C = 0$                           | -7  |       |      | V    |
| Collector-base cutoff current (Emitter open)                     | $I_{CBO}$            | $V_{\rm CB} = -20 \text{ V}, I_{\rm E} = 0$          |     |       | -0.1 | μΑ   |
| Collector-emitter cutoff current (Base open)                     | I <sub>CEO</sub>     | $V_{CE} = -10 \text{ V}, I_{B} = 0$                  |     |       | -100 | μΑ   |
| Forward current transfer ratio                                   | $h_{FE}$             | $V_{CE} = -10 \text{ V}, I_{C} = -2 \text{ mA}$      | 210 |       | 460  | _    |
| Collector-emitter saturation voltage                             | V <sub>CE(sat)</sub> | $I_C = -100 \text{ mA}, I_B = -10 \text{ mA}$        |     | - 0.2 | -0.5 | V    |
| Transition frequency   | $f_T$                | $V_{CE} = -10 \text{ V}, I_{C} = -2 \text{ mA}$      |     | 150   |      | MHz  |
| Collector output capacitance (Common base, input open circuited) | C <sub>ob</sub>      | $V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$ |     | 2     |      | pF   |

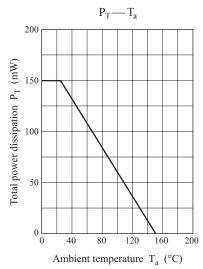
Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

#### • Tr2

| Parameter  | Symbol               | Conditions  | Min | Тур  | Max | Unit |
|--|----------------------|---|-----|------|-----|------|
| Collector-base voltage (Emitter open)                            | $V_{CBO}$            | $I_C = 10 \mu A, I_E = 0$                           | 60  |      |     | V    |
| Collector-emitter voltage (Base open)                            | V <sub>CEO</sub>     | $I_C = 2 \text{ mA}, I_B = 0$                       | 50  |      |     | V    |
| Emitter-base voltage (Collector open)                            | $V_{\mathrm{EBO}}$   | $I_E = 10 \mu A, I_C = 0$                           | 7   |      |     | V    |
| Collector-base cutoff current (Emitter open)                     | $I_{CBO}$            | $V_{CB} = 20 \text{ V}, I_{E} = 0$                  |     |      | 0.1 | μΑ   |
| Collector-emitter cutoff current (Base open)                     | I <sub>CEO</sub>     | $V_{CE} = 10 \text{ V}, I_{B} = 0$                  |     |      | 100 | μΑ   |
| Forward current transfer ratio                                   | h <sub>FE</sub>      | $V_{CE} = 10 \text{ V}, I_{C} = 2 \text{ mA}$       | 210 |      | 460 | _    |
| Collector-emitter saturation voltage                             | V <sub>CE(sat)</sub> | $I_C = 100 \text{ mA}, I_B = 10 \text{ mA}$         |     | 0.13 | 0.3 | V    |
| Transition frequency   | $f_T$                | $V_{CE} = 10 \text{ V}, I_{C} = 2 \text{ mA}$       |     | 150  |     | MHz  |
| Collector output capacitance (Common base, input open circuited) | C <sub>ob</sub>      | $V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$ |     | 1.5  |     | pF   |

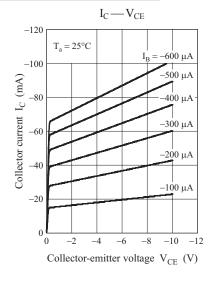
 $Note)\ Measuring\ methods\ are\ based\ on\ JAPANESE\ INDUSTRIAL\ STANDARD\ JIS\ C\ 7030\ measuring\ methods\ for\ transistors.$ 

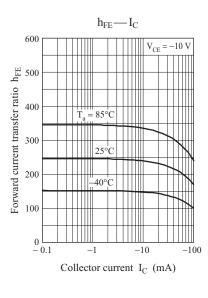
### Common characteristics chart

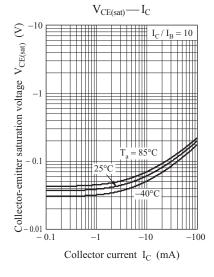


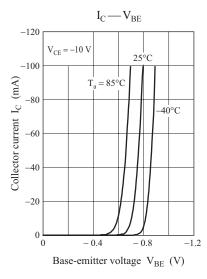
Ver. CED 2

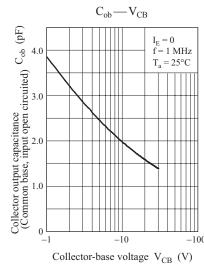
#### Characteristics charts of Tr1

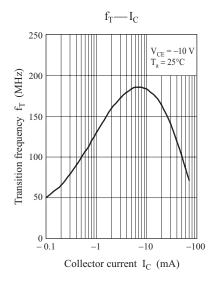




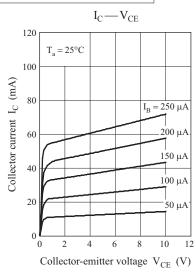


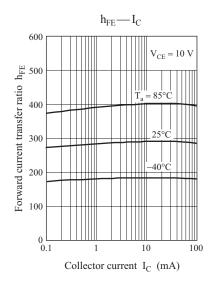


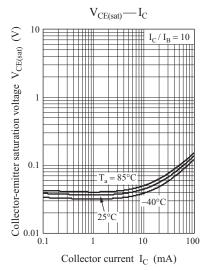




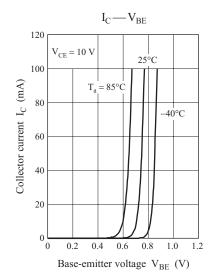
#### Characteristics charts of Tr2

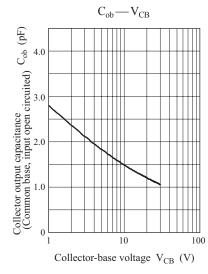


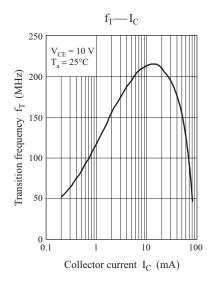




Ver. CED 3



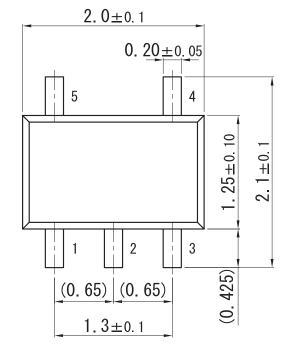


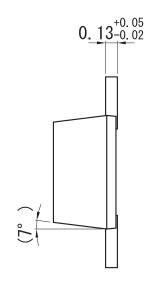


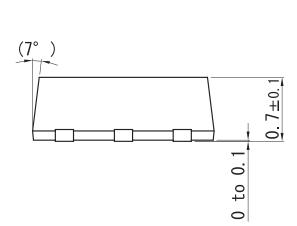
Ver. CED 4

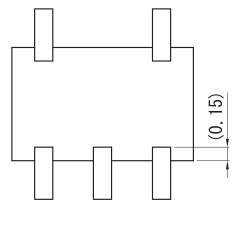
# SMini5-F3-B

Unit: mm

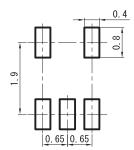








#### ■ Land Pattern (Reference) (Unit: mm)



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